

International IR Rectifier

PD - 95567

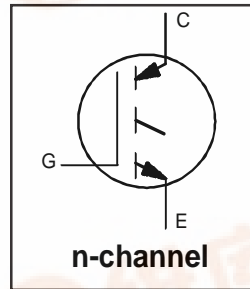
IRG4PC60F-PPbF

INSULATED GATE BIPOLAR TRANSISTOR

Fast Speed IGBT

Features

- Fast: Optimized for medium operating frequencies (1-5 kHz in hard switching, >20 kHz in resonant mode).
- Generation 4 IGBT design provides tighter parameter distribution and higher efficiency.
- Solder plated version of industry standard TO-247AC package.
- Lead-Free



$V_{CES} = 600V$
$V_{CE(on)} \text{ typ.} = 1.50V$
@ $V_{GE} = 15V, I_C = 60A$

Benefits

- Generation 4 IGBT's offer highest efficiency available.
- IGBT's optimized for specified application conditions.
- Solder plated version of the TO-247 allows the reflow soldering of the package heatsink to a substrate material.
- Designed for best performance when used with IR HEXFRED & IR FRED companion diodes.



Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Breakdown Voltage	600	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	90	A
$I_C @ T_C = 100^\circ C$	Continuous Collector Current	60	
I_{CM}	Pulsed Collector Current ①	120	
I_{LM}	Clamped Inductive Load Current ②	120	
V_{GE}	Gate-to-Emitter Voltage	± 20	V
E_{ARV}	Reverse Voltage Avalanche Energy ③	200	mJ
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	520	W
$P_D @ T_C = 100^\circ C$	Maximum Power Dissipation	210	
T_J	Operating Junction and Storage Temperature Range	-55 to + 150	$^\circ C$
T_{STG}	Soldering Temperature, for 10 seconds	300 (0.063 in. (1.6mm from case)	
	Mounting torque, 6-32 or M3 screw	10 lbf·in (1.1N·m)	
	Maximum Reflow Temperature ④	230 (Time above 183 $^\circ C$ should not exceed 100s)	

Thermal Resistance

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	---	0.24	$^\circ C/W$
$R_{\theta CS}$	Case-to-Sink, Flat, Greased Surface	0.24	---	
$R_{\theta JA}$	Junction-to-Ambient (Typical Socket Mount)	---	40	
$R_{\theta JA}$	Junction-to-Ambient (PCB Mount, Steady State)⑥	---	20	
Wt	Weight	6 (0.21)	---	g (oz)



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Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions	
V _{(BR)CES}	Collector-to-Emitter Breakdown Voltage	600	—	—	V	V _{GE} = 0V, I _C = 250μA	
V _{(BR)ECS}	Emitter-to-Collector Breakdown Voltage ④	16	—	—	V	V _{GE} = 0V, I _C = 1.0A	
ΔV _{(BR)CES} /ΔT _J	Temperature Coeff. of Breakdown Voltage	—	0.13	—	V/°C	V _{GE} = 0V, I _C = 1.0mA	
V _{CE(ON)}	Collector-to-Emitter Saturation Voltage	—	1.5	1.8	V	I _C = 60A V _{GE} = 15V	
		—	1.7	—		I _C = 90A	See Fig.2, 5
		—	1.5	—		I _C = 60A, T _J = 150°C	
V _{GE(th)}	Gate Threshold Voltage	3.0	—	6.0		V _{CE} = V _{GE} , I _C = 250μA	
ΔV _{GE(th)} /ΔT _J	Temperature Coeff. of Threshold Voltage	—	-11	—	mV/°C	V _{CE} = V _{GE} , I _C = 250μA	
g _{fe}	Forward Transconductance ⑤	36	69	—	S	V _{CE} = 100V, I _C = 60A	
I _{CES}	Zero Gate Voltage Collector Current	—	—	250	μA	V _{GE} = 0V, V _{CE} = 600V	
		—	—	2.0		V _{GE} = 0V, V _{CE} = 10V, T _J = 25°C	
		—	—	1000		V _{GE} = 0V, V _{CE} = 600V, T _J = 150°C	
I _{GES}	Gate-to-Emitter Leakage Current	—	—	±100	nA	V _{GE} = ±20V	

Switching Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q _g	Total Gate Charge (turn-on)	—	290	340	nC	I _C = 40A
Q _{ge}	Gate - Emitter Charge (turn-on)	—	40	47		V _{CC} = 400V See Fig. 8
Q _{gc}	Gate - Collector Charge (turn-on)	—	100	130		V _{GE} = 15V
t _{d(on)}	Turn-On Delay Time	—	42	—	ns	T _J = 25°C
t _r	Rise Time	—	66	—		I _C = 60A, V _{CC} = 480V
t _{d(off)}	Turn-Off Delay Time	—	310	360		V _{GE} = 15V, R _G = 5.0Ω
t _f	Fall Time	—	170	220		Energy losses include "tail"
E _{on}	Turn-On Switching Loss	—	0.30	—	mJ	See Fig. 10, 11, 13, 14
E _{off}	Turn-Off Switching Loss	—	4.6	—		
E _{ts}	Total Switching Loss	—	4.9	6.3		
t _{d(on)}	Turn-On Delay Time	—	39	—	ns	T _J = 150°C,
t _r	Rise Time	—	66	—		I _C = 60A, V _{CC} = 480V
t _{d(off)}	Turn-Off Delay Time	—	470	—		V _{GE} = 15V, R _G = 5.0Ω
t _f	Fall Time	—	300	—		Energy losses include "tail"
E _{ts}	Total Switching Loss	—	8.8	—	mJ	See Fig. 13, 14
L _E	Internal Emitter Inductance	—	13	—	nH	Measured 5mm from package
C _{ies}	Input Capacitance	—	6050	—	pF	V _{GE} = 0V
C _{oes}	Output Capacitance	—	360	—		V _{CC} = 30V See Fig. 7
C _{res}	Reverse Transfer Capacitance	—	66	—		f = 1.0MHz

Notes:

- ① Repetitive rating; V_{GE} = 20V, pulse width limited by max. junction temperature. (See fig. 13b)
- ② V_{CC} = 80%(V_{CES}), V_{GE} = 20V, R_G = 5.0Ω. (See fig. 13a)
- ③ Repetitive rating; pulse width limited by maximum junction temperature.
- ④ Pulse width ≤ 80μs; duty factor ≤ 0.1%.
- ⑤ Pulse width 5.0μs, single shot.
- ⑥ When mounted on 1" square PCB (FR-4 or G-10 Material). For recommended footprint and soldering techniques refer to application note #AN-994.
- ⑦ Refer to application note # 1023, "Surface Mounting of Larger Devices."

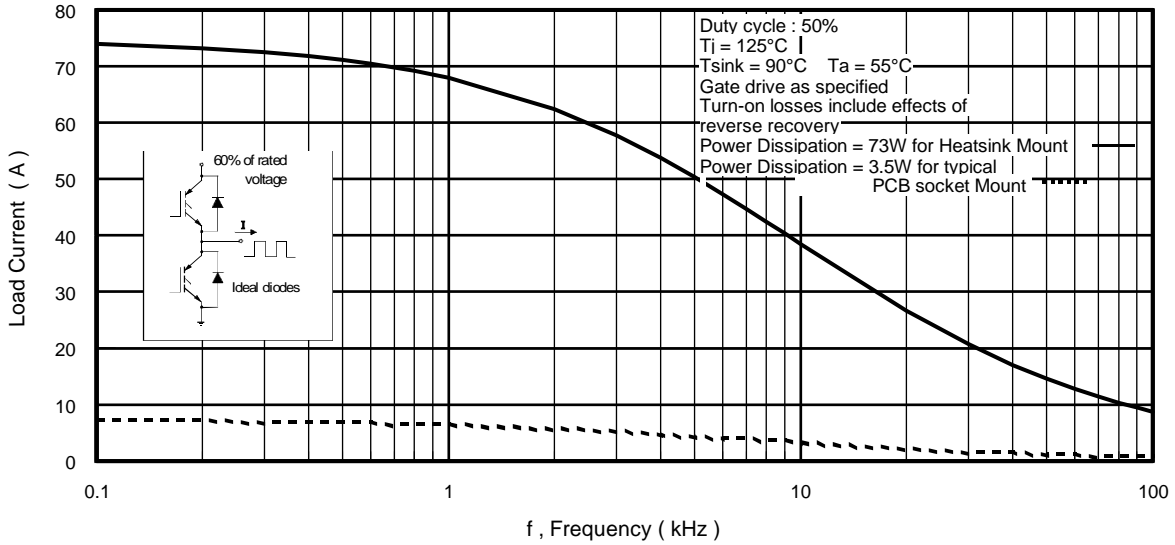


Fig. 1 - Typical Load Current vs. Frequency
 (For square wave, $I = I_{RMS}$ of fundamental; for triangular wave, $I = I_{PK}$)

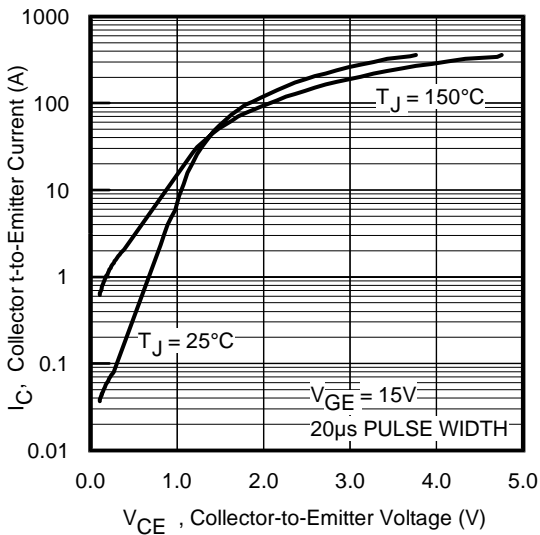


Fig. 2 - Typical Output Characteristics

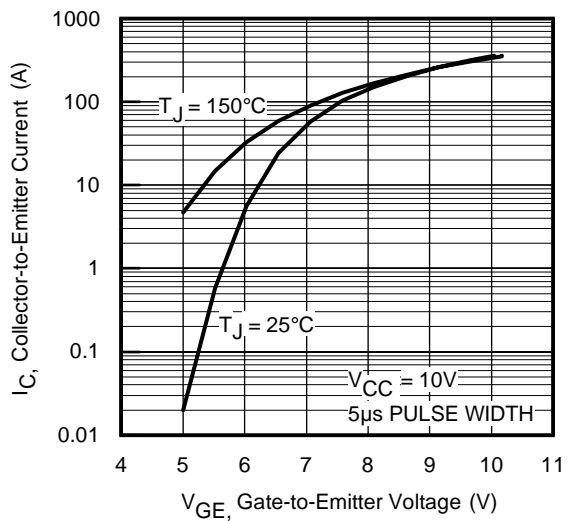


Fig. 3 - Typical Transfer Characteristics

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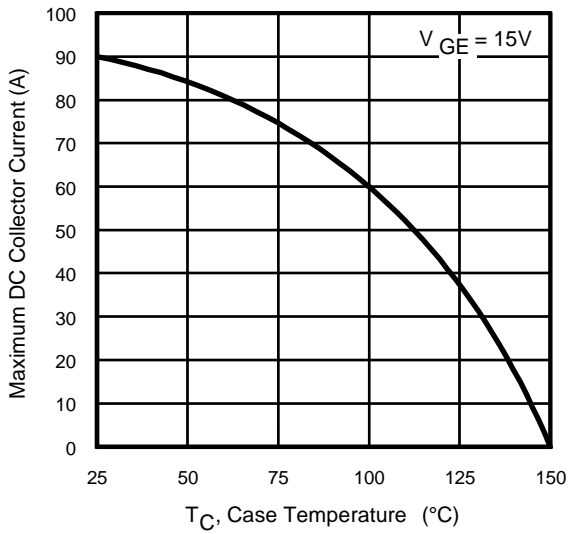


Fig. 4 - Maximum Collector Current vs. Case Temperature

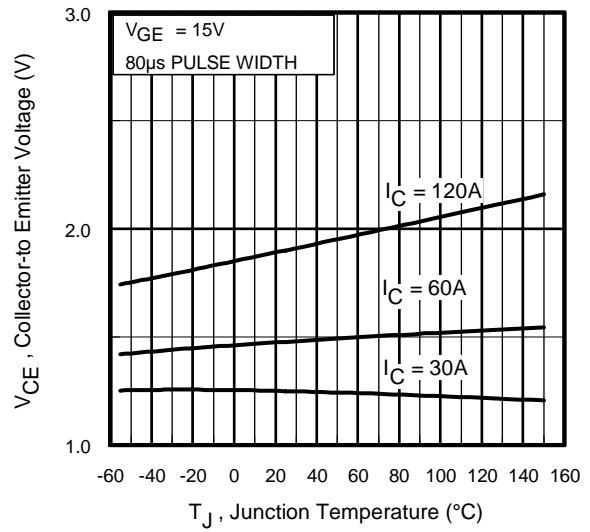


Fig. 5 - Typical Collector-to-Emitter Voltage vs. Junction Temperature

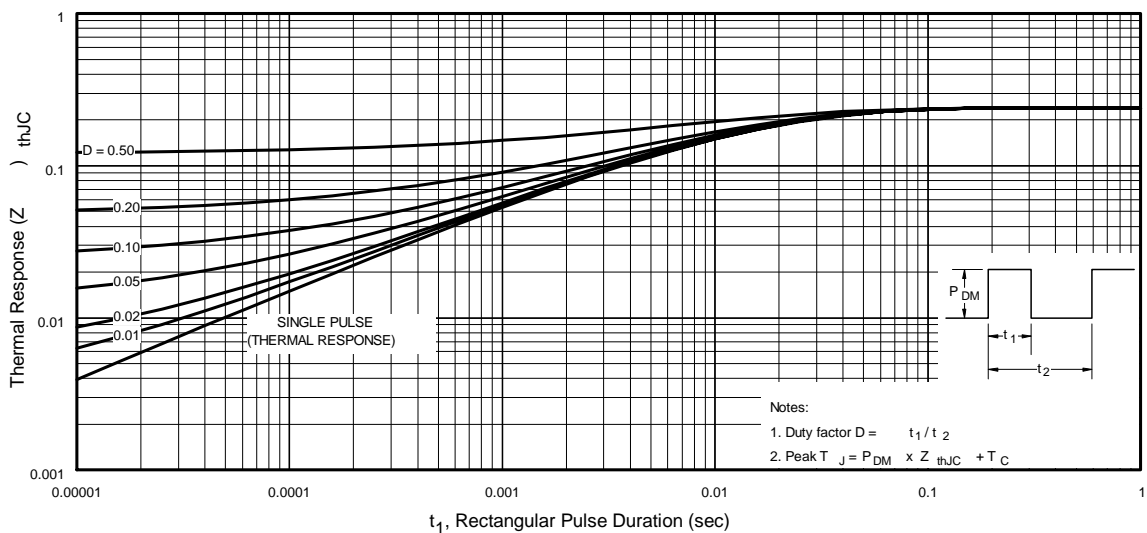


Fig. 6 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

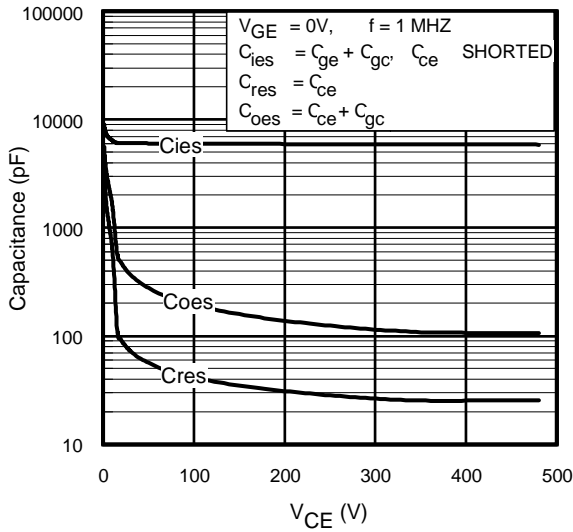


Fig. 7 - Typical Capacitance vs. Collector-to-Emitter Voltage

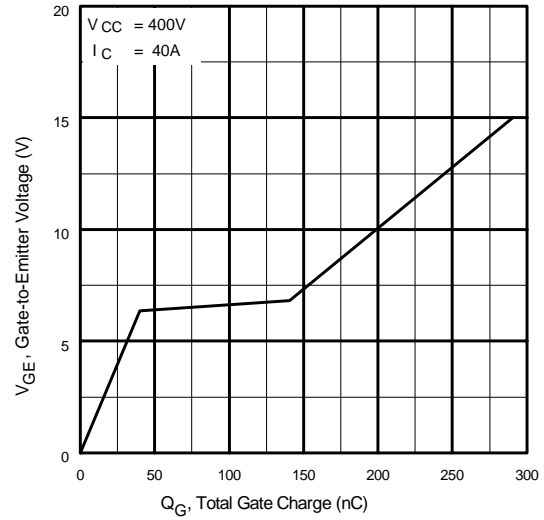


Fig. 8 - Typical Gate Charge vs. Gate-to-Emitter Voltage

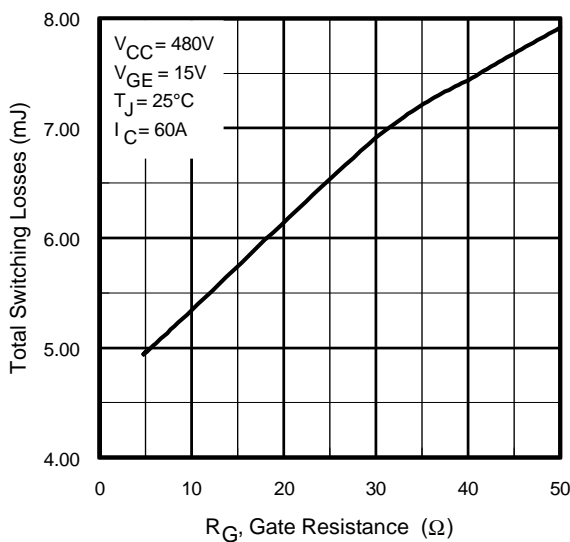


Fig. 9 - Typical Switching Losses vs. Gate Resistance

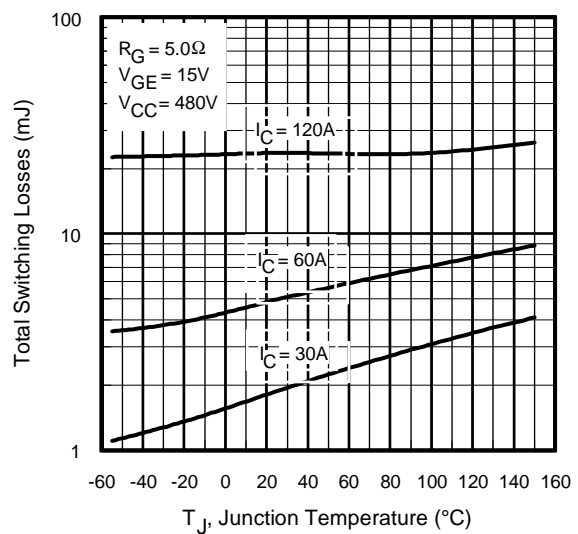


Fig. 10 - Typical Switching Losses vs. Junction Temperature

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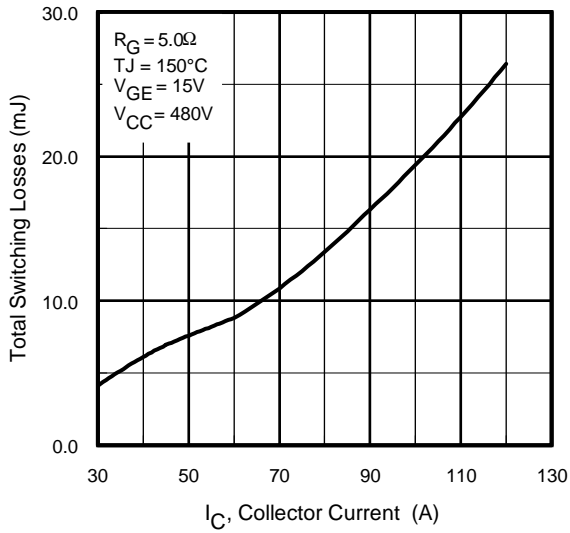


Fig. 11 - Typical Switching Losses vs. Collector-to-Emitter Current

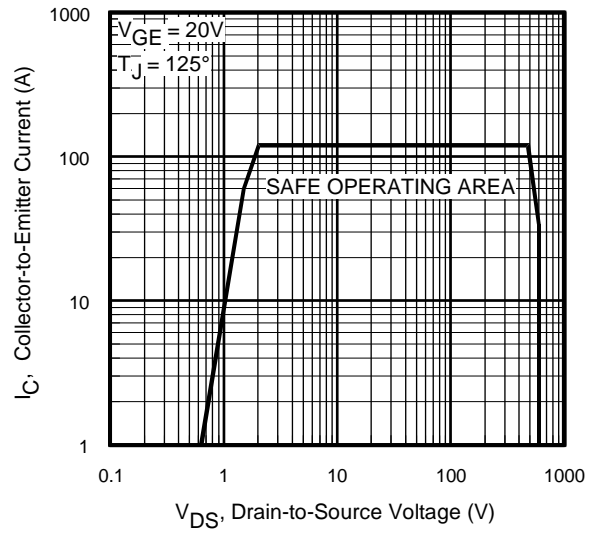


Fig. 12 - Turn-Off SOA

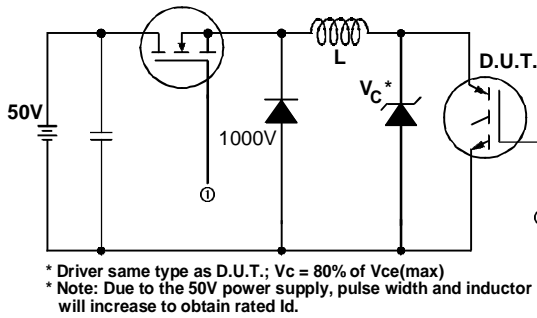


Fig. 13a - Clamped Inductive Load Test Circuit

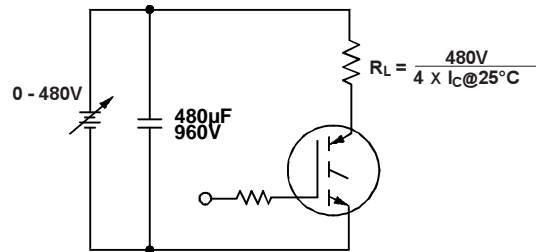


Fig. 13b - Pulsed Collector Current Test Circuit

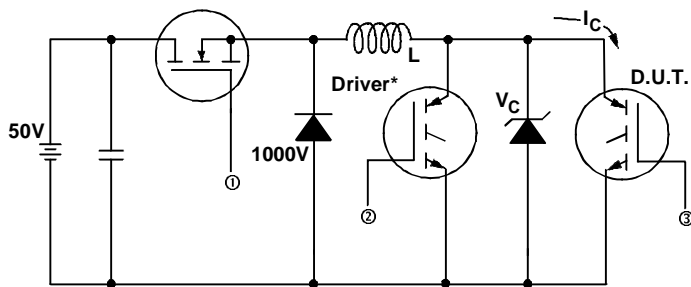


Fig. 14a - Switching Loss Test Circuit

* Driver same type as D.U.T., $V_C = 480V$

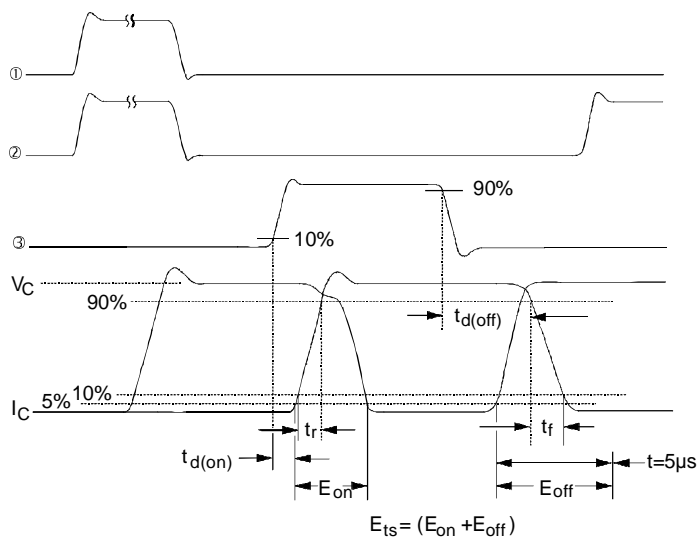
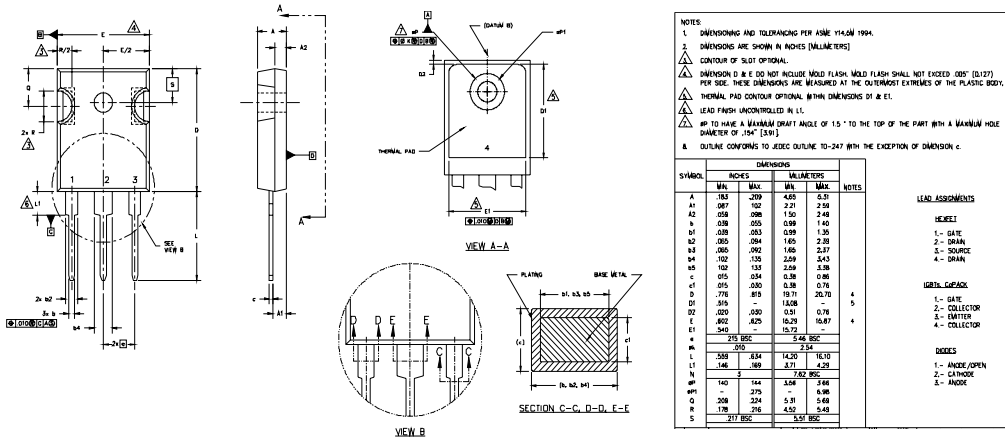


Fig. 14b - Switching Loss Waveforms

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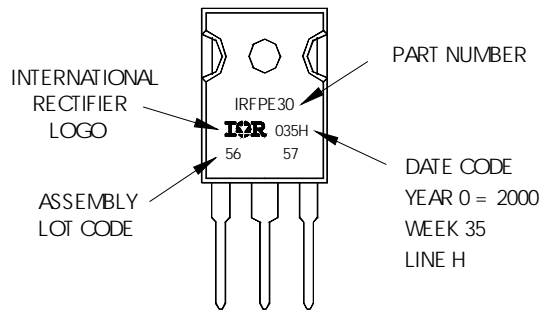
TO-247AC Package Outline



TO-247AC Part Marking Information

EXAMPLE: THIS IS AN IRFPE30
WITH ASSEMBLY
LOT CODE 5657
ASSEMBLED ON WW 35, 2000
IN THE ASSEMBLY LINE "H"

Note: "P" in assembly line position indicates "Lead-Free"



Data and specifications subject to change without notice.
This product has been designed and qualified for the Industrial market.
Qualification Standards can be found on IR's Web site.

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